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TRANSMITTAL FORM <i>(to be used for all correspondence after initial filing)</i>	Application Number	09/ 915,772
	Filing Date	July 26, 2001
	First Named Inventor	Hidetoshi Kusano
	Group Art Unit	2832
	Examiner Name	Tuyen T. Nguyen
Total Number of Pages in This Submission		Attorney Docket Number 075834.00100

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hidetoshi Kusano **Atty. Docket No.** 075834.00100
Serial No.: 09/ 915,772 **Group Art Unit:** 2832
Filed: July 26, 2001 **Examiner:** Tuyen T. Nguyen
Invention: "HIGH-FREQUENCY COIL DEVICE AND METHOD OF
MANUFACTURING THE SAME"

AMENDMENT A

Assistant Commissioner of Patents
Washington, D.C. 20231

S I R:

In response to the Office Action dated September 20, 2002, please amend the
application as follows:

IN THE CLAIMS:

1. (Once Amended) A high-frequency coil [device, characterized by] comprising:
a dielectric substrate; and
a coil formed of [a] at least one conductive layer embedded in a
[predetermined coil pattern in the] surface of said dielectric substrate, [the bottom surface]
and side [surface] surfaces of said coil [being covered by said dielectric substrate] having
substantially vertical walls as a result of plating the coil on a temporary base layer that is
removed.
2. (Once Amended) The high-frequency coil device as claimed in claim 1, wherein [a
recess is formed in the surface of said dielectric substrate, and] said coil [is designed as an
aerial wire separated from said dielectric substrate in said recess] has portions which have a
gap between a bottom surface of the coil and the substrate.